



MMBD7000

DUAL SURFACE MOUNT SWITCHING DIODE

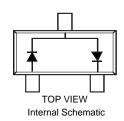
Features

- Fast Switching Speed: Maximum of 4ns
- Low Total Capacitance: Maximum of 2pF
- Surface Mount Package Ideally Suited for Automated Insertion
- For General Purpose Switching Applications
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Solderable per MIL-STD-202, Method 208 (3)
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe)
- Polarity: See Diagram
- Weight: 0.008 grams (approximate)





Ordering Information (Note 4)

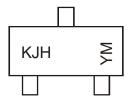
Part Number	Case	Packaging
MMBD7000-7-F	SOT23	3000/Tape & Reel

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



K = SAT (Shanghai Assembly / Test site) JH = Product Type Marking Code

YM = Date Code Marking

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Y = Year ex: Z = 2012
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M = Month ex: 9 = September



 $\label{eq:calibration} \begin{array}{l} \mathsf{C} = \mathsf{CAT} \mbox{ (Chengdu Assembly / Test site)} \\ \mathsf{JH} = \mathsf{Product} \mbox{ Type Marking Code} \\ \mathsf{YM} = \mathsf{Date} \mbox{ Code Marking} \\ \mathsf{Y} = \mathsf{Year} \mbox{ ex: } Z = 2012 \\ \mathsf{M} = \mathsf{Month} \mbox{ ex: } 9 = \mathsf{September} \end{array}$

Date Code Key

Year	1999	2000	2001	2002	2003		2012	2013	2014	2015	2016	2017	2018	2019
Code	К	L	М	Ν	Р		Z	A	В	С	D	Е	F	G
Month	Jan	Feb	Ма	ar .	Apr	Мау	Jun	Jul	Aug	Se	p	Oct	Nov	Dec
Code	1	2	3		4	5	6	7	8	9		0	Ν	D



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Non-Repetitive Peak Reverse Voltage		V _{RM}	100	V
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V _{RRM} V _{RWM} Vr	75	V
RMS Reverse Voltage		V _{R(RMS)}	53	V
Forward Continuous Current (Note 5)		I _{FM}	300	mA
Non-Repetitive Peak Forward Surge Current	@ t = 1.0μs @ t = 1.0s	I _{FSM}	2.0 1.0	А

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	PD	350	mW
Thermal Resistance Junction to Ambient Air (Note 5)	R _{0JA}	357	°C/W
Operating and Storage Temperature Range	TJ, T _{STG}	-65 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

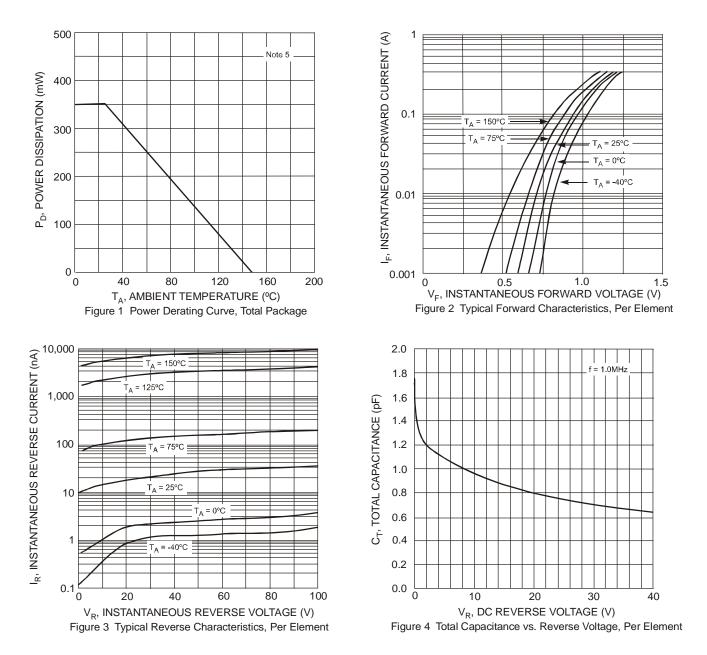
Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	V _{(BR)R}	75	_	V	I _R = 100μA
Forward Voltage	VF	0.55 0.67 0.75 —	0.70 0.82 1.10 1.25	V	I _F = 1.0mA I _F = 10mA I _F = 50mA I _F = 150mA
Reverse Current (Note 6)	I _R	_	1.0 3.0 100 25	μΑ μΑ μΑ nA	$V_R = 50V$ $V_R = 100V$ $V_R = 50V, T_J = +125^{\circ}C$ $V_R = 20V$
Total Capacitance	CT		2.0	pF	V _R = 0, f = 1.0MHz
Reverse Recovery Time	t _{rr}		4.0	ns	$I_{F} = I_{R} = 10 \text{mA},$ $I_{rr} = 0.1 \text{ x } I_{R}, R_{L} = 100 \Omega$

Notes:

Part mounted on FR-4 board with recommended pad layout, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.
Short duration pulse test used to minimize self-heating effect.

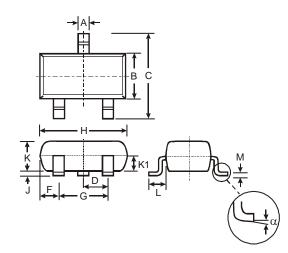


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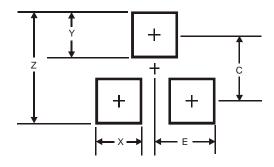


Package Outline Dimensions



SOT23						
Dim	Min	Max	Тур			
Α	0.37	0.51	0.40			
в	1.20	1.40	1.30			
С	2.30	2.50	2.40			
D	0.89	1.03	0.915			
F	0.45	0.60	0.535			
G	1.78	2.05	1.83			
н	2.80	3.00	2.90			
J	0.013	0.10	0.05			
K	0.903	1.10	1.00			
K1	-	-	0.400			
L	0.45	0.61	0.55			
М	0.085	0.18	0.11			
α	0°	8°	-			
All Dimensions in mm						

Suggested Pad Layout



Dimensions	Value (in mm)
Z	2.9
Х	0.8
Y	0.9
С	2.0
E	1.35



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